

DATE: July 30, 2021

PCN #: 2531 – Rev 2

PCN Title: Additional Die Revision, Redistribution Layer (RDL), BUMP Sites (SJSemi and LBS), as well as Assembly/Test (A/T) Site (CAT)

Dear Customer:

This is an advance announcement of change(s) to products that are currently being offered by Diodes Incorporated.

We request that you acknowledge receipt of this notification within 30 days of the date of this PCN. If you require samples for evaluation purposes, please make a request within 30 days as well. Otherwise, samples may not be built prior to this change. Please refer to the implementation date of this change as it is stated in the attached PCN form. Please contact your local Diodes sales representative to acknowledge receipt of this Advance PCN.

Previously agreed upon customer specific change process requirements or device specific requirements will be addressed separately.

For questions or clarification regarding this PCN, please contact your local Diodes sales representative.

Sincerely,

Diodes Incorporated PCN Team



PRODUCT CHANGE NOTICE

PCN-2531 REV 2

Notification Date:	Implementation Date:	Product Family:	Change Type:	PCN #:			
July 30, 2021	January 29, 2022	Analog	Additional Die Revision, RDL, BUMP and A/T Site	2531			
		TITLE	•	•			
Additional Die Revis	ion, Redistribution Layer ((RDL), BUMP Sites (A/T) Site (CAT)	(SJSEMI and LBS), as well	as Assembly/Test			
	DES	SCRIPTION OF CHA	NGE				
additional Redistribution BUMP site SJ Semicond (CAT) located in Chengd Full electrical characteriz	Layer (RDL) and BUMP sit luctor Corporation (SJSemi) u, China. zation and high reliability tes	e LB Semicon (LBS) located in JiangYin (ting is ongoing on re	assure continuity of supply, D) located in the Republic of Ko City, China, and an additional D presentative devices to ensure	rea, and an additional Diodes internal A/T site			
Please note that dates implementation dates ma		t estimates derived pletion of various qua	from close coordination with alifications over the next few mo mpleted.				
to see the attached qual			download this PCN file then ope	en it with a PDF viewer			
		IMPACT					
	There will be no change to n datasheet parameters a		Function of products affected ance.	d, unless specifically			
	P	RODUCTS AFFECTI	ED				
Table 2 - Qualifying Ac Table 3 -Qualifying Ad	dditional Die Revision, Ad dditional RDL and BUMP S ditional BUMP Site (LBS) ditional BUMP Site (SJSe	Site (LBS)					
WEB LINKS							
Manufacturer's Notice:	https://www.	diodes.com/quality/pr	oduct-change-notices/diodes-pr	oduct-change-notices/			
For More Information C	ontact: <u>https://www.</u>	diodes.com/about/coi	ntact-us/contact-sales/				
Data Sheet:	http://www.d	http://www.diodes.com/catalog/					



Table 1 - Qualifying Additional Die Revision, Additional A/T Site (CAT)							
AP3445LW6-7							

Table 2 - Qualifying Additional RDL and BUMP Site (LBS)							
AP22908CN4-7	AP22908CNA4-7						

Table 3 - Qualifying Additional BUMP Site (LBS)							
AP22913CN4-7	AP22916BCA4-7	AP22916CCA4-7					

Table 4 - Qualifying Additional BUMP Site (SJSemi), Additional A/T Site (CAT)							
AP61100Z6-7	AP61	102Z6-7	AP61300Z6-7	AP61302Z6-7			